

**MOTOROLA
SEMICONDUCTOR
TECHNICAL DATA**


*Discrete
Military
Operation*

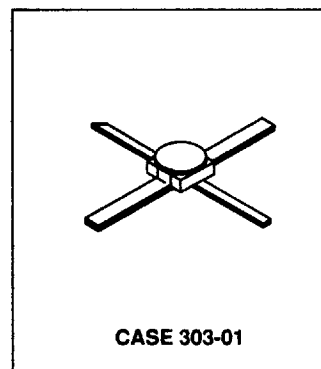
PRELIMINARY DATA

MRFS3866AHXV/HS

PROCESSED TO MIL-S-19500/398

**SURFACE MOUNTABLE
R.F. TRANSISTOR**

30 VOLT, 400 MILLIAMPERE BIPOLAR NPN


MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	30	Vdc
Collector-Base Voltage	V_{CBO}	60	Vdc
Emitter-Base Voltage	V_{EBO}	3.5	Vdc
Collector Current — Continuous	I_C	400	mAdc
Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_T	200 1.14	mW mW/°C
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to +200	°C

This document contains information on a new product. Specifications and information herein are subject to change without notice.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless noted)				
Characteristic	Symbol	Min	Max	Unit
Collector-Emitter Breakdown Voltage $I_C = 5.0 \text{ mA}$	$V_{(BR)CEO}$	30	—	Vdc
Collector-Emitter Breakdown Voltage $I_C = 40 \text{ mA}$, $V_{BE} = 1.5 \text{ Vdc}$	$V_{(BR)CEX}$	55	—	Vdc
Collector-Base Breakdown Voltage $I_C = 100 \mu\text{A}$	$V_{(BR)CBO}$	60	—	Vdc
Emitter-Base Breakdown Voltage $I_E = 100 \mu\text{A}$	$V_{(BR)EBO}$	3.5	—	Vdc
Collector Cutoff Current $V_{CE} = 28 \text{ Vdc}$	I_{CEO}	—	20	μA
Collector Cutoff Current $V_{CE} = 55 \text{ Vdc}$ $V_{CE} = 55 \text{ Vdc}$, $T_A = +150^\circ\text{C}$	I_{CES}	— —	0.1 2.0	mA
DC Current Gain $I_C = 50 \text{ mA}$, $V_{CE} = 5.0 \text{ Vdc}$ $I_C = 360 \text{ mA}$, $V_{CE} = 5.0 \text{ Vdc}$ $I_C = 50 \text{ mA}$, $V_{CE} = 5.0 \text{ Vdc}$, $T_A = -55^\circ\text{C}$	h_{FE}	25 8.0 12	200 — —	—
Collector-Emitter Saturation Voltage $I_C = 100 \text{ mA}$, $I_B = 10 \text{ mA}$	$V_{CE(sat)}$	—	1.0	Vdc
Output Capacitance $V_{CB} = 28 \text{ Vdc}$, $I_E = 0$, $f = 0.1$ to 1.0 MHz	C_{obo}	—	3.0	pF
Small-Signal Current Transfer Ratio, Magnitude $I_C = 50 \text{ mA}$, $V_{CE} = 15 \text{ Vdc}$, $f = 200 \text{ MHz}$	$ h_{fe} $	4.0	7.5	—
Output Power $V_{CC} = 28 \text{ Vdc}$, $f = 400 \text{ MHz}$, $P_{in} = 0.15 \text{ W}$ $V_{CC} = 28 \text{ Vdc}$, $f = 400 \text{ MHz}$, $P_{in} = 0.075 \text{ W}$	P_{out}	1.0 0.5	2.0 —	W
Collector Efficiency $V_{CC} = 28 \text{ Vdc}$, $f = 400 \text{ MHz}$, $P_{in} = 0.15 \text{ W}$ $V_{CC} = 28 \text{ Vdc}$, $f = 400 \text{ MHz}$, $P_{in} = 0.075 \text{ W}$	η	45 40	— —	%

ASSURANCE TESTING (Pre/Post Burn-In)				
Burn-In Test Conditions: $T_A = 30 \pm 5^\circ\text{C}$, $V_{CB} = 28 \text{ Vdc}$, $P_T = 200 \text{ mW}$				
Characteristics Tested	Symbol	Min	Max	Unit
Collector Cutoff Current $V_{CE} = 28 \text{ Vdc}$	I_{CEO}	—	20	μA
DC Current Gain $I_C = 50 \text{ mA}$, $V_{CE} = 5.0 \text{ Vdc}$	h_{FE}	25	200	—

Delta from Pre-Burn-In Measured Values				
Delta Collector Cutoff Current	ΔI_{CEO}		100 or 2.0	% initial μA
Delta DC Current Gain	Δh_{FE}		±20	whichever is greater % initial